

CMLDM7003
CMLDM7003G*
CMLDM7003J

SURFACE MOUNT SILICON
DUAL N-CHANNEL
ENHANCEMENT-MODE
MOSFETS



SOT-563 CASE

* Device is *Halogen Free* by design



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DESCRIPTION:

These CENTRAL SEMICONDUCTOR devices are dual N-Channel enhancement-mode MOSFETs, manufactured by the N-Channel DMOS Process, designed for high speed pulsed amplifier and driver applications. The CMLDM7003 utilizes the USA pinout configuration, while the CMLDM7003J utilizes the Japanese pinout configuration. These devices offer low $r_{DS(ON)}$ and ESD protection up to 2kV.

MARKING CODES: CMLDM7003: C30
CMLDM7003G*: C3G
CMLDM7003J: C3J

MAXIMUM RATINGS: ($T_A=25^\circ\text{C}$)

	SYMBOL	UNITS
Drain-Source Voltage	V_{DS}	V
Drain-Gate Voltage	V_{DG}	V
Gate-Source Voltage	V_{GS}	V
Continuous Drain Current	I_D	mA
Maximum Pulsed Drain Current	I_{DM}	A
Power Dissipation (Note 1)	P_D	mW
Power Dissipation (Note 2)	P_D	mW
Power Dissipation (Note 3)	P_D	mW
Operating and Storage Junction Temperature	T_J, T_{stg}	$^\circ\text{C}$
Thermal Resistance	Θ_{JA}	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS PER TRANSISTOR: ($T_A=25^\circ\text{C}$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{GSSF}, I_{GSSR}	$V_{GS}=5.0\text{V}$			100	nA
I_{GSSF}, I_{GSSR}	$V_{GS}=10\text{V}$			2.0	μA
I_{GSSF}, I_{GSSR}	$V_{GS}=12\text{V}$			2.0	μA
I_{DSS}	$V_{DS}=50\text{V}, V_{GS}=0$			50	nA
BV_{DSS}	$V_{GS}=0, I_D=10\mu\text{A}$	50			V
$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	0.49		1.0	V
V_{SD}	$V_{GS}=0, I_S=115\text{mA}$			1.4	V
$r_{DS(\text{ON})}$	$V_{GS}=1.8\text{V}, I_D=50\text{mA}$		1.6	3.0	Ω
$r_{DS(\text{ON})}$	$V_{GS}=2.5\text{V}, I_D=50\text{mA}$		1.3	2.5	Ω
$r_{DS(\text{ON})}$	$V_{GS}=5.0\text{V}, I_D=50\text{mA}$		1.1	2.0	Ω
g_{FS}	$V_{DS}=10\text{V}, I_D=200\text{mA}$	200			mS
C_{rss}	$V_{DS}=25\text{V}, V_{GS}=0, f=1.0\text{MHz}$			5.0	pF
C_{iss}	$V_{DS}=25\text{V}, V_{GS}=0, f=1.0\text{MHz}$			50	pF
C_{oss}	$V_{DS}=25\text{V}, V_{GS}=0, f=1.0\text{MHz}$			25	pF
$Q_{g(\text{tot})}$	$V_{DS}=25\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	0.764			nC
Q_{gs}	$V_{DS}=25\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	0.148			nC
Q_{gd}	$V_{DS}=25\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	0.156			nC

Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 4.0mm²

(2) FR-4 Epoxy PC Board with copper mounting pad area of 4.0mm²

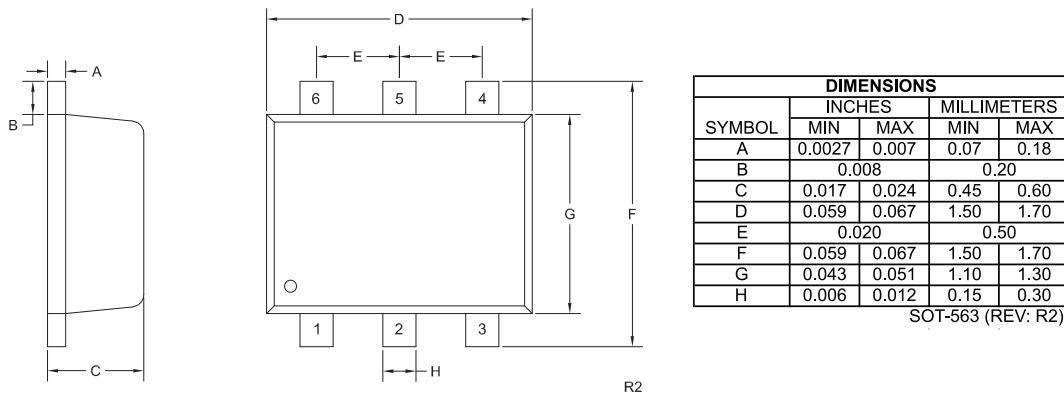
(3) FR-4 Epoxy PC Board with copper mounting pad area of 1.4mm²

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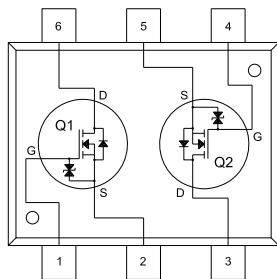


SOT-563 CASE - MECHANICAL OUTLINE



PIN CONFIGURATIONS

**CMLDM7003 (USA Pinout)
CMLDM7003G***

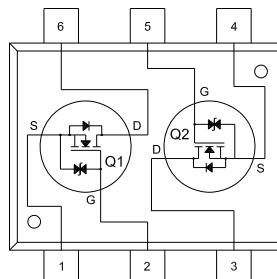


LEAD CODE:
1) Gate Q1
2) Source Q1
3) Drain Q2
4) Gate Q2
5) Source Q2
6) Drain Q1

MARKING CODES:
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CMLDM7003J (Japanese Pinout)



LEAD CODE:
1) Source Q1
2) Gate Q1
3) Drain Q2
4) Source Q2
5) Gate Q2
6) Drain Q1

MARKING CODE: C3J

R9 (8-June 2015)

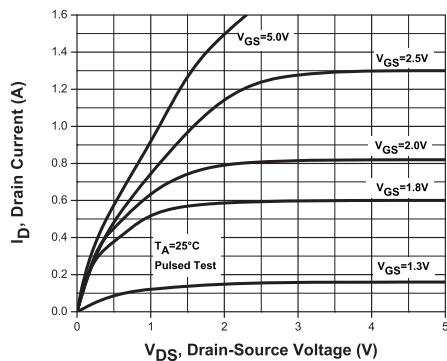
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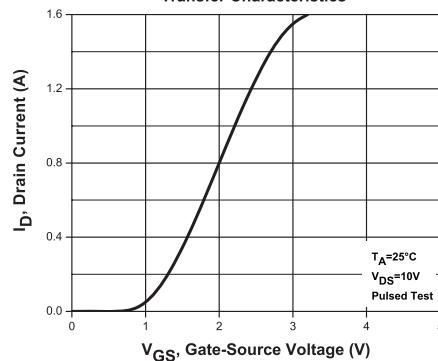


TYPICAL ELECTRICAL CHARACTERISTICS

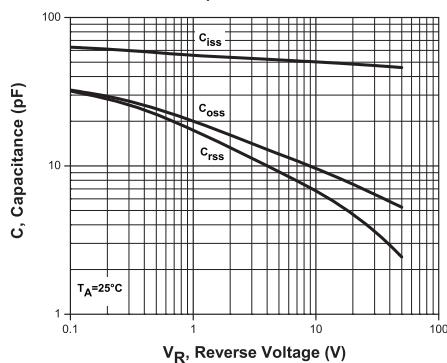
Output Characteristics



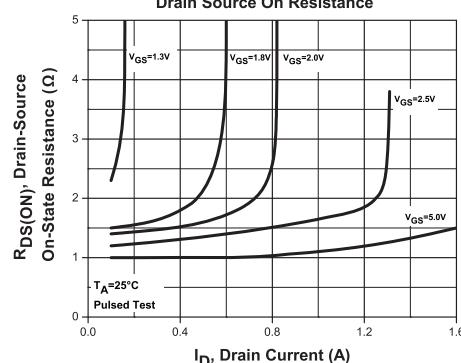
Transfer Characteristics



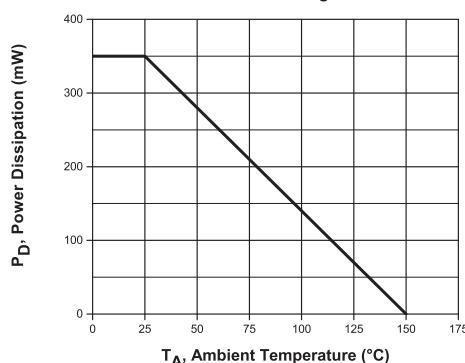
Capacitance



Drain Source On Resistance



Power Derating



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